

Vishay Siliconix

# N-Channel 150 V (D-S) MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	150				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0088				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.010				
Q <sub>g</sub> typ. (nC)	24.5				
I <sub>D</sub> (A)	70.2				
Configuration	Single				

#### **FEATURES**

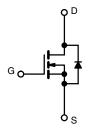
- TrenchFET® Gen V power MOSFET
- Very low R<sub>DS</sub> x Q<sub>g</sub> figure-of-merit (FOM)
- Tuned for the lowest R<sub>DS</sub> x Q<sub>oss</sub> FOM
- 100 % R<sub>a</sub> and UIS tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

## RoHS COMPLIANT HALOGEN

**FREE** 

### **APPLICATIONS**

- · Synchronous rectification
- · Primary side switch
- DC/DC converters
- Power supplies
- Motor drive control



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SIR578DP-T1-RE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	150	V	
Gate-source voltage		$V_{GS}$	± 20	v	
	T <sub>C</sub> = 25 °C		70.2		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1 .	56.1		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	17.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	13.7 <sup>b, c</sup>	^	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	200	Α	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		94		
	T <sub>A</sub> = 25 °C	l <sub>S</sub>	5.6 <sup>b, c</sup>		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	30		
Single pulse avalanche energy	L = 0.1 IIII	E <sub>AS</sub>	45	mJ	
	T <sub>C</sub> = 25 °C		104		
Maximum power dissipation	T <sub>C</sub> = 70 °C		66.6	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	6.25 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C		4 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) c			260	-0	

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	15	20	°C/W		
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	0.9	1.2	C/VV		

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 54 °C/W
- g.  $T_C = 25$  °C

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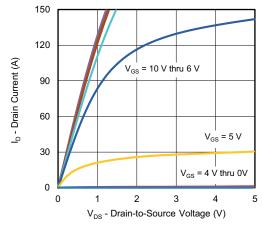
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•			<u>'</u>	l	·
Drain-source breakdown voltage	$V_{DS}$	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA		-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	$I_D = 10 \text{ mA}$		105	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-7.0	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	-	4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	100	nA
Zoro noto voltono duois ovument		V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	40	-	-	Α
Drain-source on-state resistance <sup>a</sup>	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	0.0073	0.0088	Ω
Drain-source on-state resistance "	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 15 A	-	0.00825	0.010	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A	-	62	-	S
Dynamic <sup>b</sup>						•
Input capacitance	C <sub>iss</sub>		-	2540	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	325	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	6.6	-	
Tatal asta shaws	0	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	32.5	49	
Total gate charge	Q <sub>g</sub>		-	24.5	37	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 20 \text{ A}$	-	15.3	-	nC
Gate-drain charge	$Q_{gd}$		-	3.1	-	
Output charge	Q <sub>oss</sub>	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$	-	105	-	
Gate resistance	$R_g$	f = 1 MHz	0.5	1.35	2.3	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	16	32	
Rise time	t <sub>r</sub>	$V_{DD} = 75 \text{ V}, R_L = 3.75 \Omega, I_D \cong 20 \text{ A},$	-	22	44	<del>-</del>
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	23	46	
Fall time	t <sub>f</sub>		-	23	46	
Turn-on delay time	t <sub>d(on)</sub>		-	18	36	ns
Rise time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, \text{ R}_L = 3.75 \Omega, \text{ I}_D \cong 20 \text{ A},$	-	68	136	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$	-	21	42	
Fall time	t <sub>f</sub>		-	24	48	
<b>Drain-Source Body Diode Characteristi</b>	cs					
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	94	^
Pulse diode forward current	I <sub>SM</sub>		-	-	200	A
Body diode voltage	V <sub>SD</sub>	$I_{S} = 5 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.75	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	85	170	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	200	400	nC
Reverse recovery fall time	t <sub>a</sub>	$T_{\rm J} = 25  ^{\circ}{\rm C}$	-	65	-	
Reverse recovery rise time	t <sub>b</sub>		-	20	-	ns

#### Notes

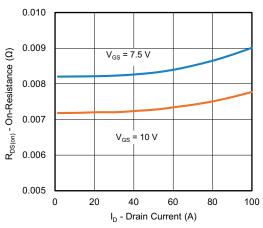
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

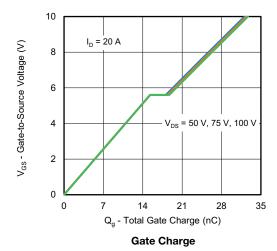


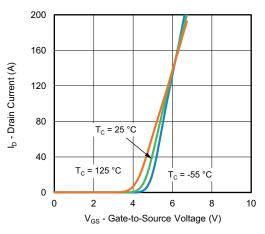


### **Output Characteristics**

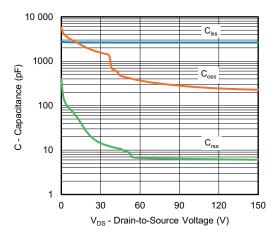


On-Resistance vs. Drain Current and Gate Voltage

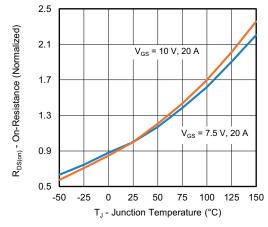




**Transfer Characteristics** 

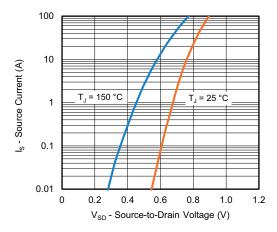


Capacitance

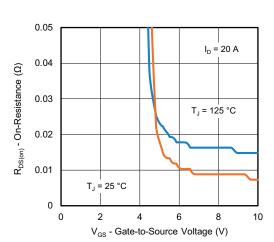


On-Resistance vs. Junction Temperature

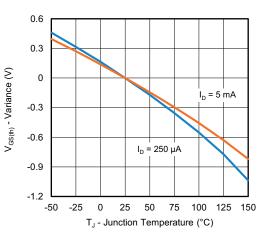




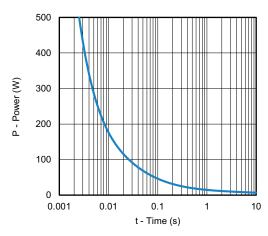
Source-Drain Diode Forward Voltage



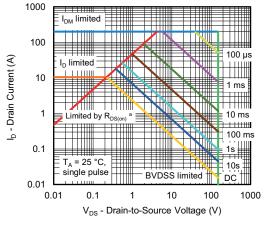
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient

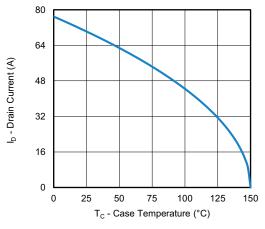


Safe Operating Area, Junction-to-Ambient

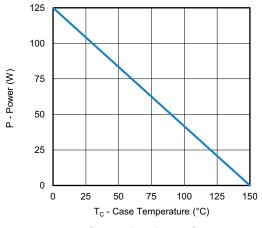
#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

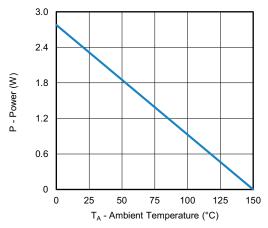




Current Derating a



Power, Junction-to-Case

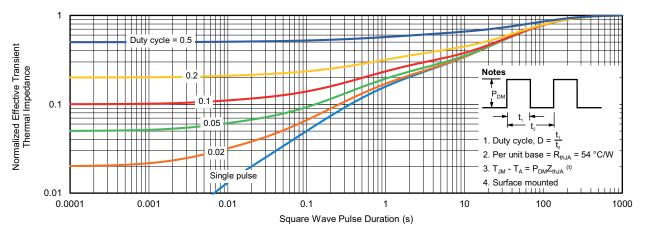


Power, Junction-to-Ambient

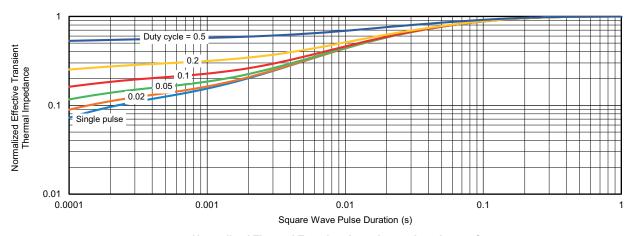
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?63019">www.vishay.com/ppg?63019</a>.

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# PowerPAK® SO-8, (Single/Dual)



DIM.		MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4		0.57 typ.			0.0225 typ.		
D5		3.98 typ.		0.157 typ.			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4		0.75 typ.		0.030 typ.			
е		1.27 BSC		0.050 BSC			
K		1.27 typ.		0.050 typ.			
K1	0.56	-	-	0.022	-	-	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М		0.125 typ.			0.005 typ.		

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DWG: 5881



## RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE

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